

NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

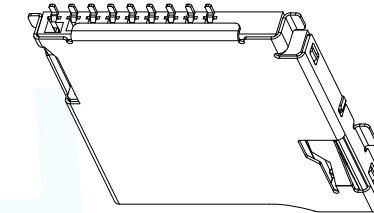
2.PLATING:

UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

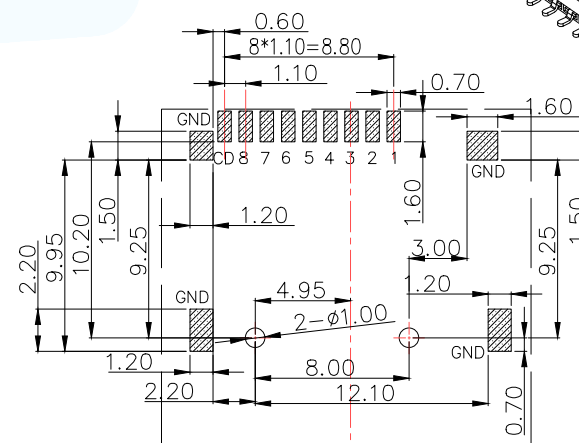
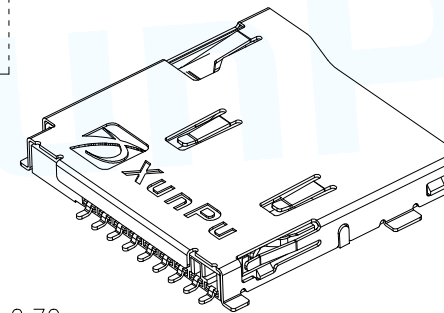
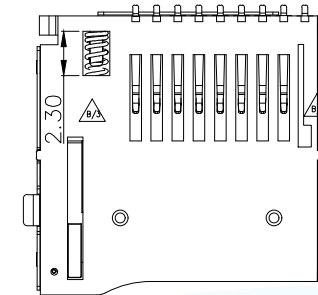
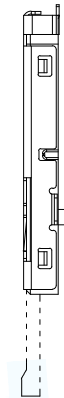
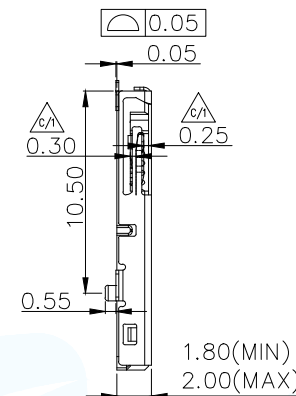
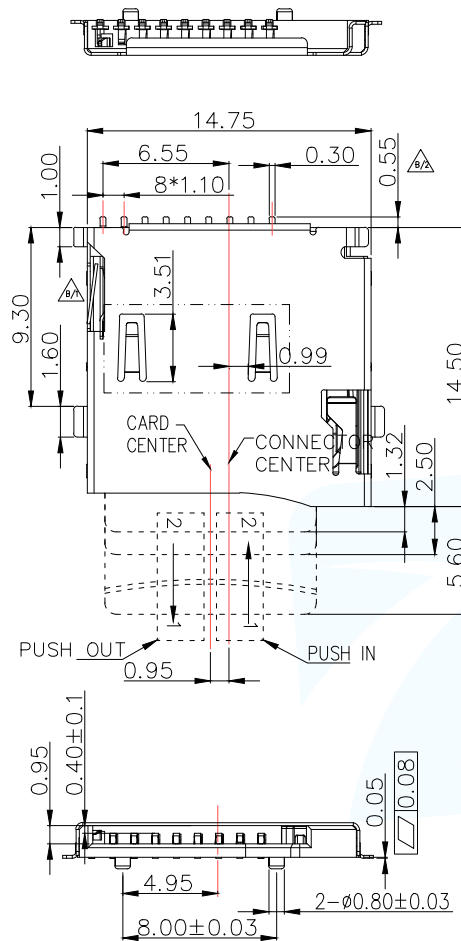
SOLDER AREA: TIN OVER NICKEL.

3.MULTIMEDIA CARD COMPATIBLE



TF CARD PIN DEFINE			
PIN NO.	NAME	YYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SD CARD PUSH PUSH SMT 双压片 外焊	
			PAR	TF-115K
DECIMALS:	ANGLES:		DWN	YAO
X.X: ±0.35	X.X': ±3°		CHKD	
X.XX: ±0.25	X.XX': ±2°		APVD	
X.XXX: ±0.15		CUSTOMER COPY	SCALE1: 1	UNIT: MM
			SIZE: A4	SHEET: 1F1
				REV: A



Circuit Diagram for Detect Switch

PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

WITHOUT CARD	CLOSE	CLOSE
	CD	CD GND(SHIELD)
INSERTING CARD	OPEN	OPEN
	CD	CD GND(SHIELD)